

FIG.1

Docket No. 10970792-4 Multilayered Ceramic Substrate S rving as Ink Manifold and Electrical Interconnection Platform for Multiple Printhead Dies Melissa D. Boyd et al. 2/10

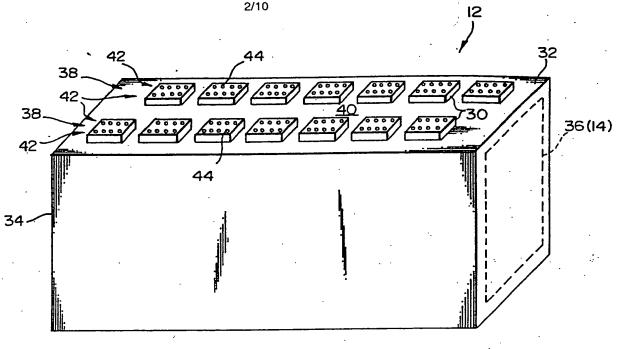
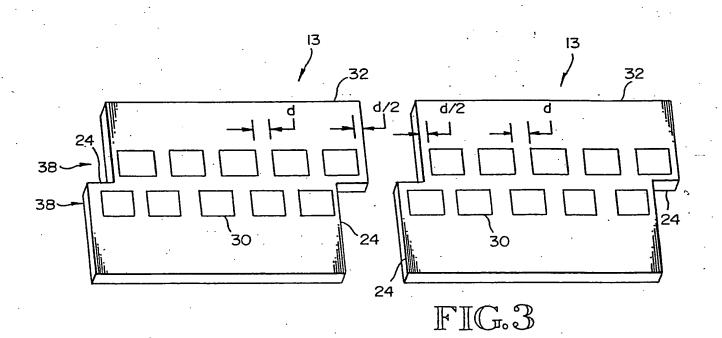
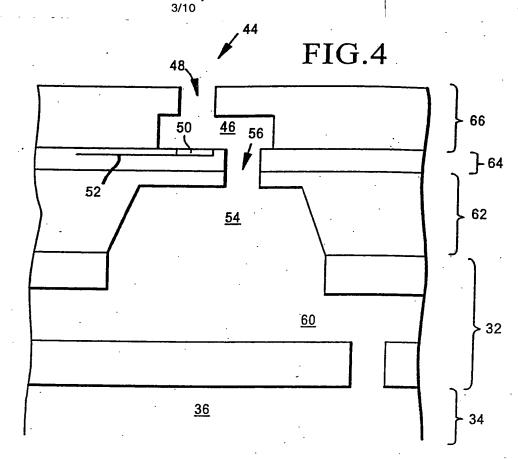
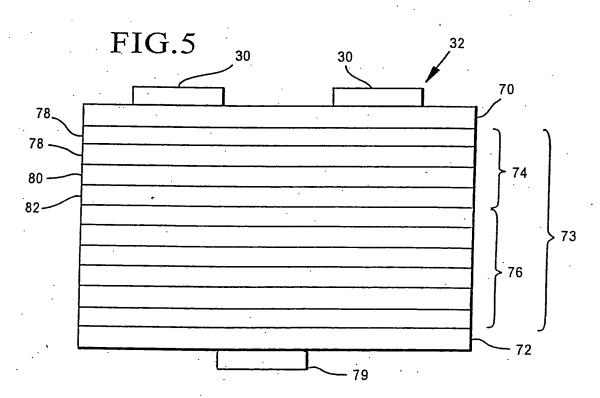
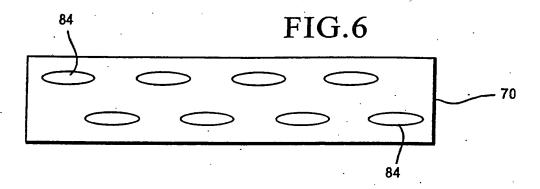


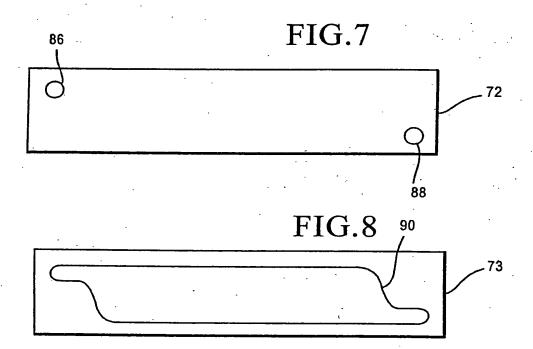
FIG.2

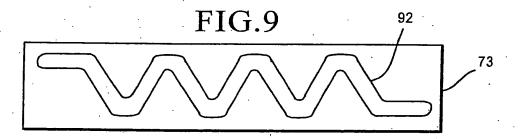






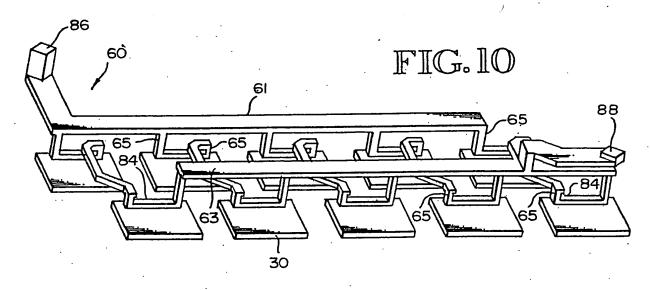


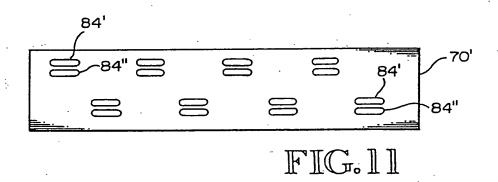


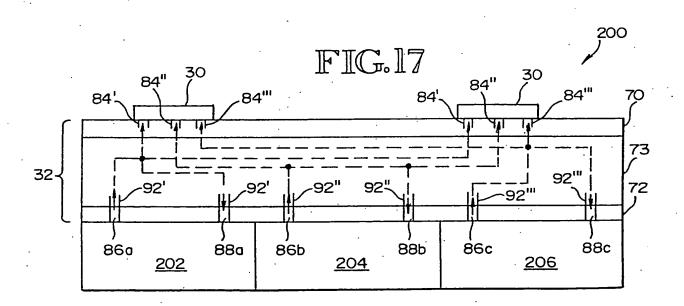


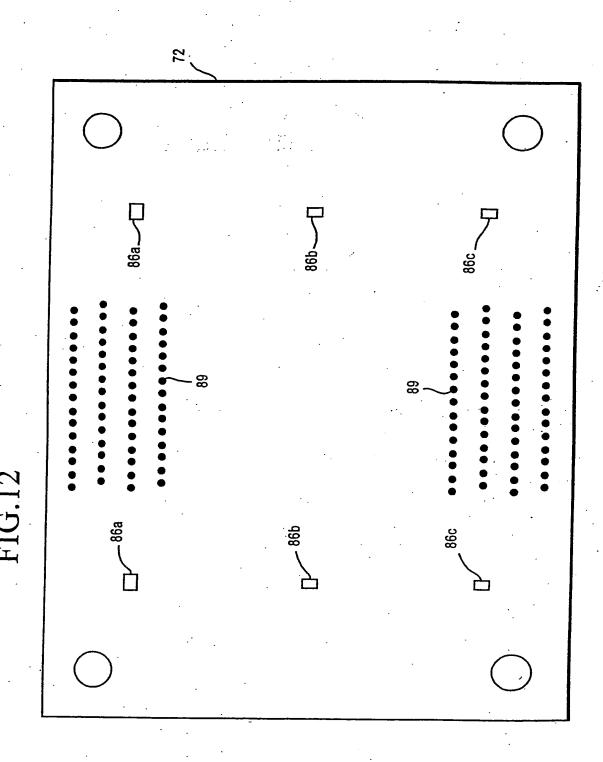
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Multilayered Ceramic Substrate Serving as Ink Manifold and Electrical Interconnection Platf rm for Multiple Printh ad Dies Melissa D. Boyd et al. 5/10









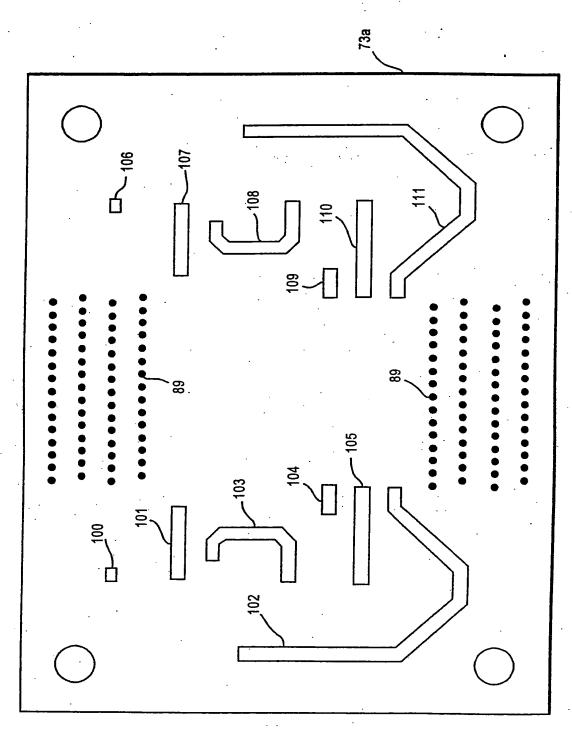


FIG. 13

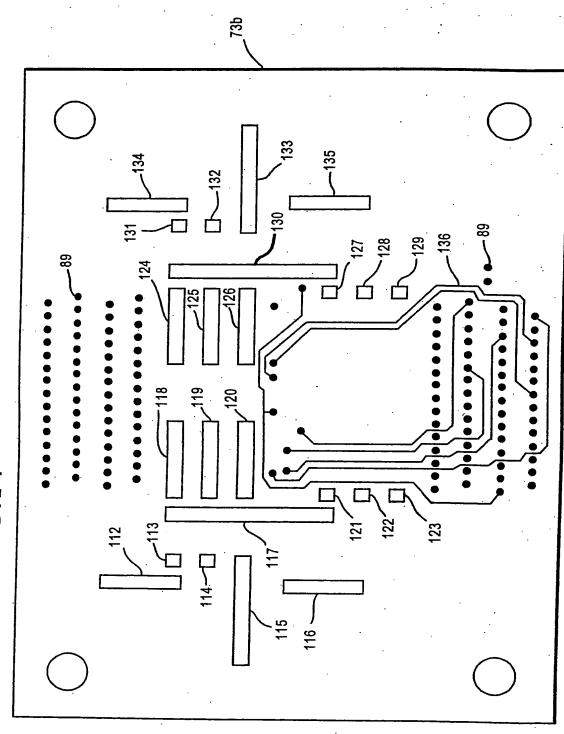


FIG. 14

